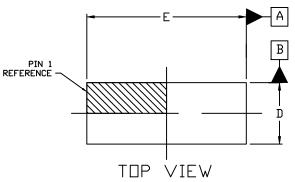
0.05 C

7 0.03 C

WLCSP40 1.60x4.15x0.33

CASE 567XS ISSUE O

DATE 12 APR 2019

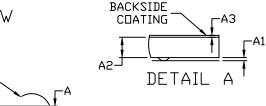


DETAIL A

SIDE VIEW

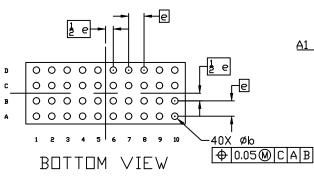
NOTES:

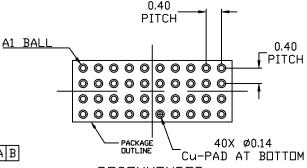
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPERICAL CROWNS OF THE CONTACT BALLS.
- 4. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE CONTACT BALLS.
- 5. DIMENSION 6 IS MEASURED AT THE MAXIMUM CONTACT BALL DIAMETER PARALLEL TO DATUM C.



SEATING PLANE

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	0.31	0.33	0.35	
A1	0.034	0.040	0.046	
A2	0.2525	0.2650	0.2775	
A3	0.020	0.025	0.030	
b	0.15	0.17	0.19	
D	1.575	1.600	1.625	
E	4.125	4.150	4.175	
е	0.40 BSC			





RECOMMENDED
MOUNTING FOOTPRINT*
NSMD TYPE

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

GENERIC MARKING DIAGRAM*

° XXXXXXXX AWLYYWW

XXX = Specific Device Code

A = Assembly Location

WL = Wafer Lot

YY = Year WW = Work Week *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	WLCSP40 1.60x4.15x0.33		PAGE 1 OF 1	

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